



JIANGSU CHANGJIANG ELECTRONICS TECHNOLOGY CO., LTD

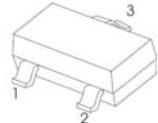
SOT-23 Plastic-Encapsulate MOSFETs

CJ2306 N-Channel 30-V(D-S) MOSFET

FEATURE

TrenchFET Power MOSFET

SOT-23

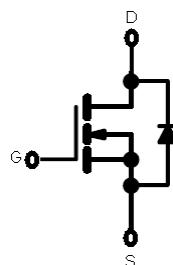


1. GATE
2. SOURCE
3. DRAIN

APPLICATIONS

- Load Switch for Portable Devices
- DC/DC Converter

MARKING: S6



Maximum ratings (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J=150^\circ\text{C}$) ^{a,b}	I_D	3.16	A
Pulsed Drain Current	I_{DM}	20	
Continuous Source Current(Diode Conduction) ^{a,b}	I_S	0.62	
Maximum Power Dissipation ^{a,b}	P_D	0.75	W
Thermal Resistance from Junction to Ambient ($t \leq 5\text{s}$)	$R_{\theta JA}$	100	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

Notes :

- a. Surface Mounted on 1" \times 1" FR4 board, $t \leq 5\text{s}$.
- b. Pulse width limited by maximum junction temperature.

Electrical characteristics (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Gate-Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.0		3.0	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 0\text{V}$			0.5	μA
Drain-Source On-Resistance ^a	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 3.5\text{A}$		0.038	0.047	Ω
		$V_{\text{GS}} = 4.5\text{V}, I_D = 2.8\text{A}$		0.052	0.065	
Forward Transconductance ^a	g_{fs}	$V_{\text{DS}} = 4.5\text{V}, I_D = 2.5\text{A}$		7.0		S
Diode Forward Voltage	V_{SD}	$I_S = 1.25\text{A}, V_{\text{GS}} = 0\text{V}$		0.8	1.2	V
Dynamic						
Gate Charge	Q_g	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 5\text{V}, I_D = 2.5\text{A}$		3.0	4.5	nC
Total Gate Charge	Q_{gt}	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 2.5\text{A}$		6	9	
Gate-Source Charge	Q_{gs}			1.6		
Gate-Drain Charge	Q_{gd}			0.6		
Gate Resistance	R_g	$f = 1.0\text{MHz}$	2.5	5	7.5	Ω
Input Capacitance	C_{iss}	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		305		pF
Output Capacitance	C_{oss}			65		
Reverse Transfer Capacitance	C_{rss}			29		
Switching						
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{\text{DD}} = 15\text{V}, R_L = 15\Omega, I_D \approx 1\text{A}, V_{\text{GEN}} = 10\text{V}, R_g = 6\Omega$		7	11	ns
Rise Time	t_r			12	18	
Turn-Off Delay Time	$t_{d(\text{off})}$			14	25	
Fall Time	t_f			6	10	

Notes :

a.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.